Characteristics STTH506

Characteristics

Table 2. Absolute ratings (limiting values at 25° C, unless otherwise specified)

Symbol	Paramet	Value	Unit		
V_{RRM}	Repetitive peak reverse voltage		600	V	
1	RMS forward current	TO-220AC	20	Α	
IF(RMS)	KWS forward current	DPAK	10	Α	
I _{F(AV)}	Average forward current, δ = 0.5, square wave.	T _c = 145° C	TO-220AC DPAK	5	Α
1.	Surge non repetitive forward current	t _p = 10 ms	TO-220AC	70	Α
I _{FSM}	Surge non repetitive forward current	DPAK	55	Α	
T _{stg}	Storage temperature range	-65 to +175	°C		
T _j	Maximum operating junction tempera		175	ů	

Table 3. Thermal parameters

Symbol	Parameter	Max. value	Unit
R _{th(j-c)}	Junction to case	3.5	° C/W

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур	Max.	Unit
I _R ⁽¹⁾	I _R ⁽¹⁾ Reverse leakage current		V - V	-		5	μA
'R`	Neverse leakage current	T _j = 150° C	$V_R = V_{RRM}$	-	13	130	μΛ
V _E ⁽²⁾	Forward voltage drop	T _j = 25° C	I _F = 5 A	-		1.85	V
VF` ′	Trofward vollage drop	T _j = 150° C		-	1.10	1.40	

^{1.} Pulse test: $t_p = 5$ ms, $\delta < 2\%$

To evaluate the conduction losses, use the following equation: P = 1.07 x $I_{F(AV)}$ + 0.066 x I_{F}^{2} _(RMS)

$$P = 1.07 \times I_{\text{F}}(x) + 0.066 \times I_{\text{F}}^{2}(x)$$

DocID12380 Rev 4 2/11

^{2.} Pulse test: $t_p = 380 \mu s$, $\delta < 2\%$

STTH506 Characteristics

Table 5. Dynamic characteristics

Symbol	Parameter	Test	Test conditions		Тур	Max.	Unit	
t _{rr}	Reverse recovery time	T _j = 25° C	$I_F = 0.5 A$ $I_{rr} = 0.25 A$ $I_R = 1 A$	-		30	nc	
	Treverse recovery time		$I_F = 1 \text{ A}$ $V_R = 30 \text{ V}$ $dI_F/dt = -50 \text{ A/}\mu\text{s}$	-	35	50	- ns	
I _{RM}	Reverse recovery current		I _F = 5 A	•	3.5	5	Α	
Q _{rr}	Reverse recovery charges	T _j = 125° C	$V_R = 400 \text{ V}$ $dI_F/dt = -100 \text{ A/}\mu\text{s}$	-	175		nC	
t _{fr}	Forward recovery time		I _F = 5 A	•		180	ns	
V_{FP}	Forward recovery voltage	T _j = 25° C	$V_{FR} = 1.1 \text{ x } V_{Fmax}$ $dI_F/dt = 100 \text{ A/}\mu\text{s}$	-	4		٧	

Characteristics STTH506

Figure 1. Conduction losses versus average current

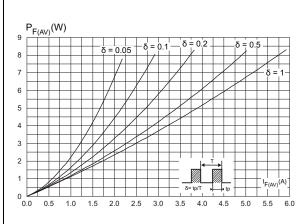


Figure 2. Forward voltage drop versus forward current

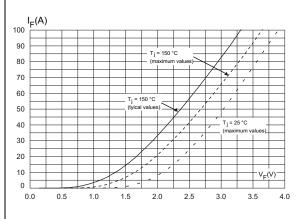


Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

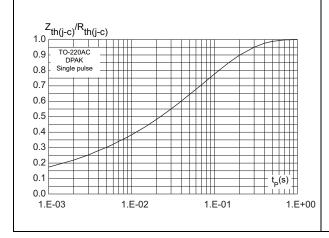


Figure 4. Peak reverse recovery current versus dl_F/dt (typical values)

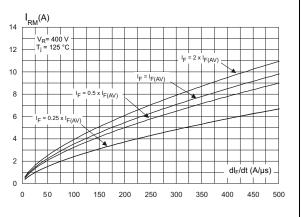


Figure 5. Reverse recovery time versus dl_F/dt (typical values)

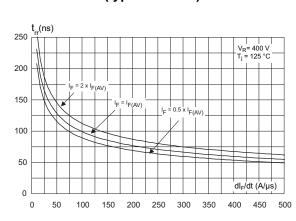
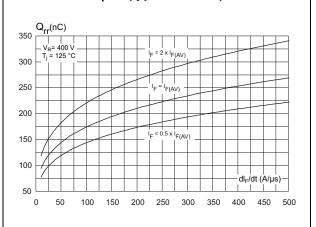


Figure 6. Reverse recovery charges versus dl_F/dt (typical values)



4/11 DocID12380 Rev 4

STTH506 Characteristics

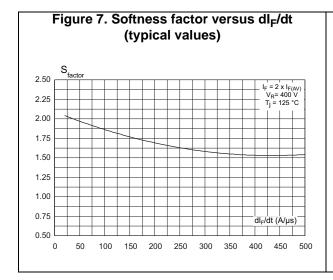


Figure 8. Relative variations of dynamic parameters versus junction temperature

1.50
1.25
1.00
0.75
0.50
0.25
0.00
25
50
75
100
125

Figure 9. Transient peak forward voltage versus dl_F/dt (typical values) $V_{FP}(V)$

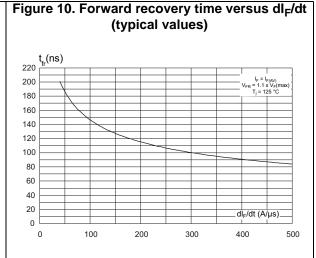
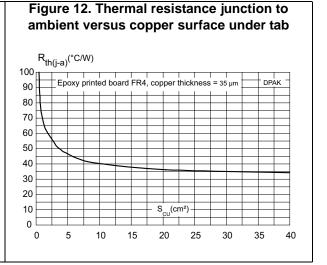


Figure 11. Junction capacitance versus reverse voltage applied (typical values)

C(pF)

V_R(V)

1 01 100 1000



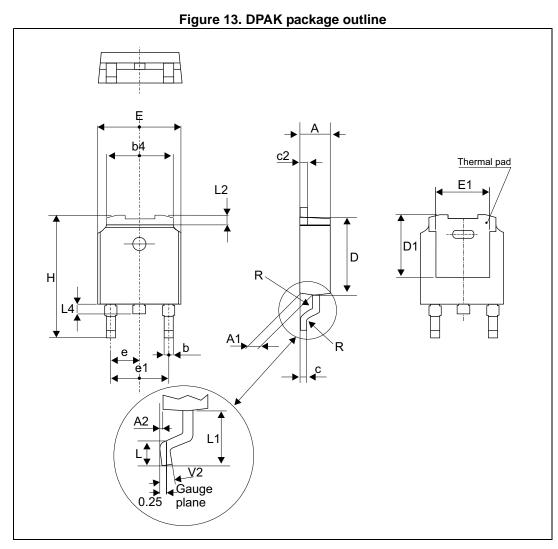
Package Information STTH506

2 **Package Information**

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.55 Nm for TO-220AC
- Maximum torque value: 0.7 Nm for TO-220AC

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

2.1 **DPAK** package information



Note:

Downloaded from **Arrow.com**.

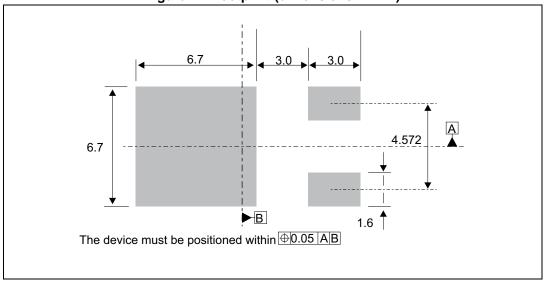
This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

6/11 DocID12380 Rev 4

Table 6. DPAK package mechanical data

	Dimensions							
Ref.	Millimeters			Inches				
	Min.	Тур.	Max.	Min.	Тур.	Max.		
Α	2.18		2.40	0.085		0.094		
A1	0.90		1.10	0.035		0.043		
A2	0.03		0.23	0.001		0.009		
b	0.64		0.90	0.025		0.035		
b4	4.95		5.46	0.194		0.214		
С	0.46		0.61	0.018		0.024		
c2	0.46		0.60	0.018		0.023		
D	5.97		6.22	0.235		0.244		
D1	4.95		5.60	0.194		0.220		
E	6.35		6.73	0.250		0.264		
E1	4.32		5.50	0.170		0.216		
е		2.28			0.090			
e1	4.40		4.70	0.173		0.185		
Н	9.35		10.40	0.368		0.409		
L	1.00		1.78	0.039		0.070		
L2			1.27			0.050		
L4	0.60		1.02	0.023		0.040		
V2	-8°		+8°	-8°		8°		

Figure 14. Footprint (dimensions in mm)





Package Information STTH506

2.2 TO-220AC package information

H2 Ø١ L5 L7 L6 L2 L9 D F1 L4 F M Ε G

Figure 15. TO-220AC package outline



Table 7. TO-220AC package mechanical data

	Dimensions								
Ref.	Millimeters			Inches					
	Min.	Тур.	Max.	Min.	Тур.	Max.			
А	4.40		4.60	0.173		0.181			
С	1.23		1.32	0.048		0.051			
D	2.40		2.72	0.094		0.107			
Е	0.49		0.70	0.019		0.027			
F	0.61		0.88	0.024		0.034			
F1	1.14		1.70	0.044		0.066			
G	4.95		5.15	0.194		0.202			
H2	10.00		10.40	0.393		0.409			
L2		16.40 typ.			0.645 typ.				
L4	13.00		14.00	0.511		0.551			
L5	2.65		2.95	0.104		0.116			
L6	15.25		15.75	0.600		0.620			
L7	6.20		6.60	0.244		0.259			
L9	3.50		3.93	0.137		0.154			
M		2.6 typ.			0.102 typ.				
Diam. I	3.75		3.85	0.147		0.151			



9/11

Ordering Information STTH506

3 Ordering Information

Table 8. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STTH506B-TR	STTH 506B	DPAK	0.30 g	2500	Tape and reel
STTH506B	STTH 506B	DPAK	0.30 g	75	Tube
STTH506D	STTH506D	TO-220AC	1.86 g	50	Tube

4 Revision history

Table 9. Document revision history

Date	Revision	Description of Changes	
14-Oct-2008	1	First issue.	
U8-AU0-2014 I 2 I		Updated DPAK package information and removed TO-220AB package.	
26-Nov-2014	3	Updated Figure 13 and Figure 14.	
03-Nov-2016 4		Updated DPAK package information and reformatted to current standard.	

IMPORTANT NOTICE - PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2016 STMicroelectronics – All rights reserved



DocID12380 Rev 4 11/11